



# PJP75N75

## 75V N-Channel Enhancement Mode MOSFET

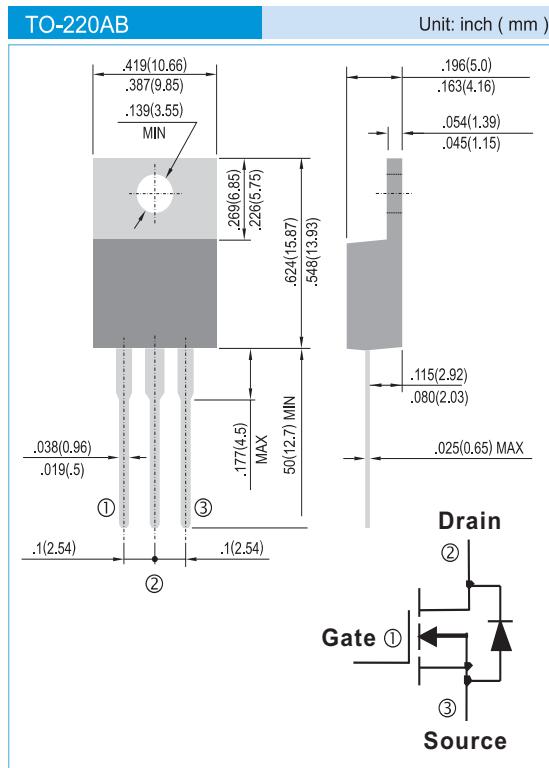
### FEATURES

- $R_{DS(ON)}$ ,  $V_{GS}$  @ 10V,  $I_{DS}$  @ 30A = 11mΩ

- Advanced Trench Process Technology
- High Density Cell Design For Ultra Low On-Resistance
- Specially Designed for Converters and Power Motor Controls
- Fully Characterized Avalanche Voltage and Current
- In compliance with EU RoHS 2002/95/EC directives

### MECHANICAL DATA

- Case: TO-220AB Molded Plastic
- Terminals : Solderable per MIL-STD-750, Method 2026
- Marking : P75N75



### Maximum RATINGS and Thermal Characteristics ( $T_A=25^\circ C$ unless otherwise noted)

PARAMETER	Symbol	Limit	Units
Drain-Source Voltage	$V_{DS}$	75	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D$	75	A
Pulsed Drain Current <sup>1)</sup>	$I_{DM}$	350	A
Maximum Power Dissipation	$P_D$	105 62.5	W
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	°C
Avalanche Energy with Single Pulse $I_{AS}=47A$ , $VDD=37.5V$ , $L=0.3mH$	$E_{AS}$	660	mJ
Junction-to-Case Thermal Resistance	$R_{\theta JC}$	1.2	°C/W
Junction-to Ambient Thermal Resistance(PCB mounted) <sup>2)</sup>	$R_{\theta JA}$	62	°C/W

Note: 1. Maximum DC current limited by the package

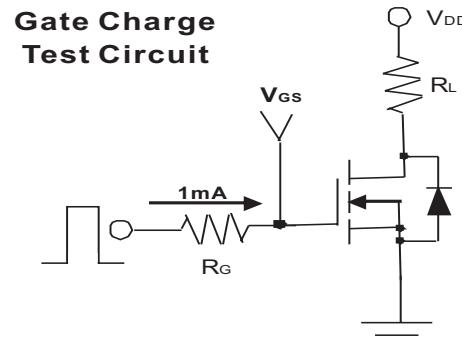
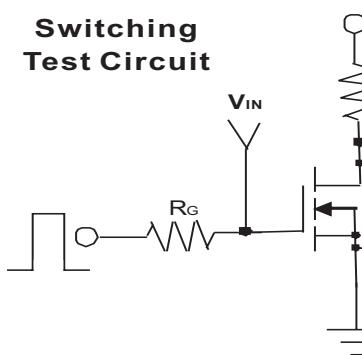
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## ELECTRICAL CHARACTERISTICS ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Units
<b>Static</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	75	-	-	V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	1	-	3	V
Drain-Source On-State Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=30\text{A}$	-	8.0	11	$\text{m}\Omega$
		$V_{\text{GS}}=10\text{V}, I_{\text{D}}=30\text{A}, T_c=125^\circ\text{C}$	-	-	20	
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}}=75\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
		$V_{\text{DS}}=75\text{V}, V_{\text{GS}}=0\text{V}, T_c=125^\circ\text{C}$	-	-	10	
Gate Body Leakage	$I_{\text{GSS}}$	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	nA
Forward Transconductance	$g_{\text{fs}}$	$V_{\text{DS}} > I_{\text{D}(\text{ON})} \times R_{\text{DS}(\text{ON})\text{max}}, I_{\text{D}}=15\text{A}$	20	-	-	S
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	$V_{\text{DS}}=30\text{V}, I_{\text{D}}=30\text{A}$ $V_{\text{GS}}=10\text{V}$	-	83	-	nC
Gate-Source Charge	$Q_{\text{gs}}$		-	8.9	-	
Gate-Drain Charge	$Q_{\text{gd}}$		-	24.3	-	
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}}=30\text{V}, R_L=15\Omega$ $I_{\text{D}}=2\text{A}, V_{\text{GEN}}=10\text{V}$ $R_G=2.5\Omega$	-	18.2	22	ns
Turn-On Rise Time	$t_r$		-	15.6	20	
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		-	70.5	90	
Turn-Off Fall Time	$t_f$		-	13.8	18	
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}$ $f=1.0\text{MHz}$	-	3150	-	pF
Output Capacitance	$C_{\text{oss}}$		-	300	-	
Reverse Transfer Capacitance	$C_{\text{rss}}$		-	240	-	
<b>Source-Drain Diode</b>						
Max. Diode Forward Current	$I_s$	-	-	-	75	A
Diode Forward Voltage	$V_{\text{SD}}$	$I_s=30\text{A}, V_{\text{GS}}=0\text{V}$	-	0.85	1.5	V





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Typical Characteristics Curves ( $T_a=25^\circ\text{C}$ , unless otherwise noted)

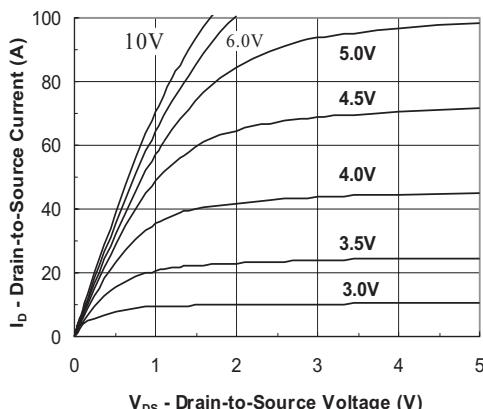


FIG.1- Output Characteristic

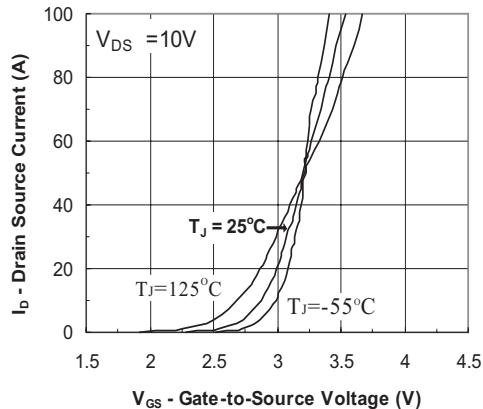


FIG.2- Transfer Characteristic

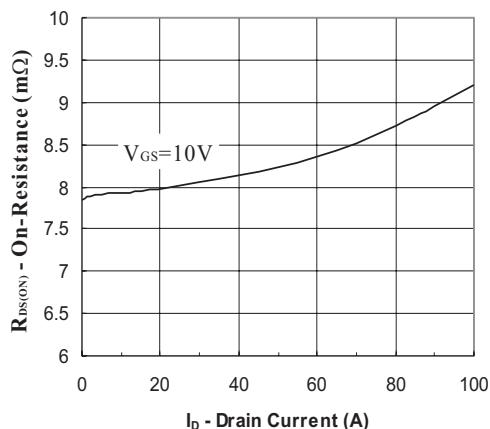


FIG.3- On Resistance vs Drain Current

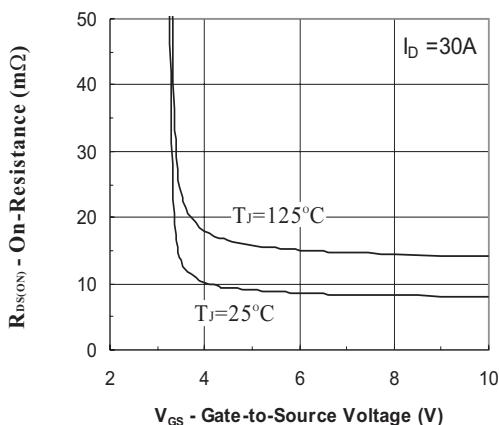


FIG.4- On Resistance vs Gate to Source Voltage

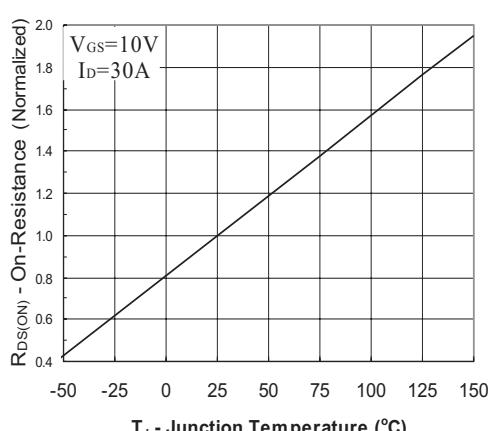


FIG.5- On Resistance vs Junction Temperature

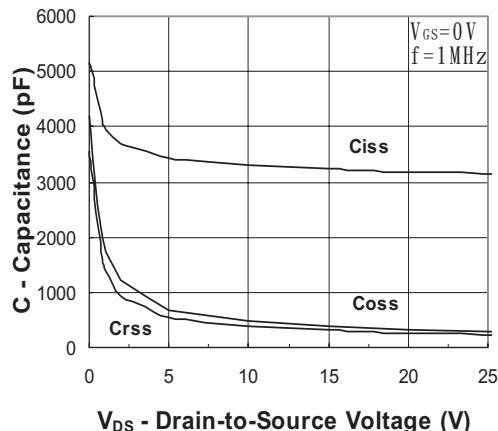


FIG.6 - Capacitance



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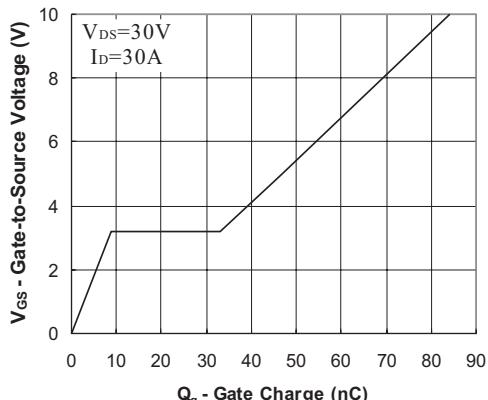


Fig.7 - Gate Charge

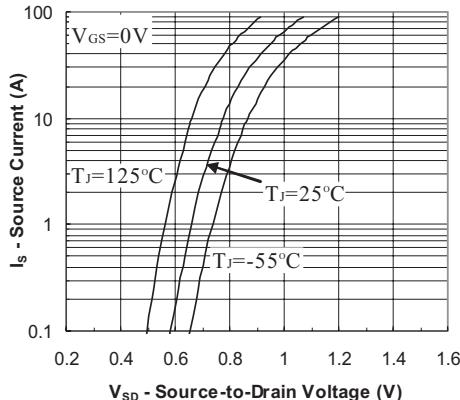


Fig.10 - Source-Drain Diode Forward Voltage

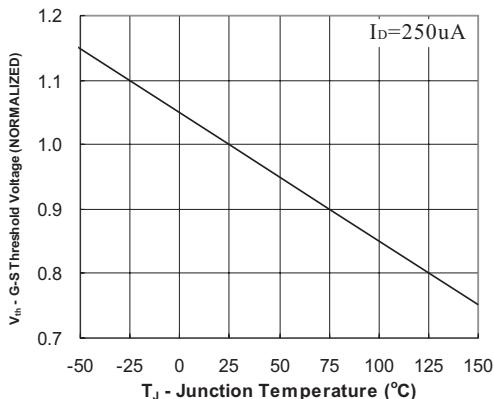


Fig.8 - Threshold Voltage vs Junction Temperature

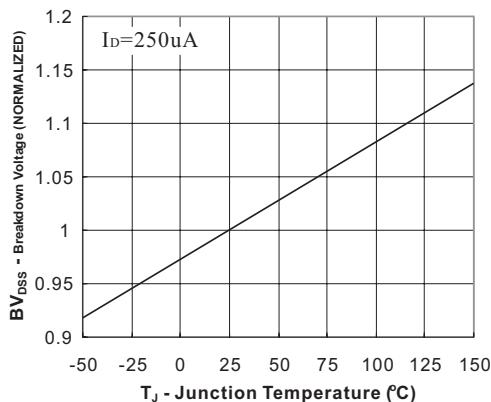


Fig.9 - Breakdown Voltage vs Junction Temperature

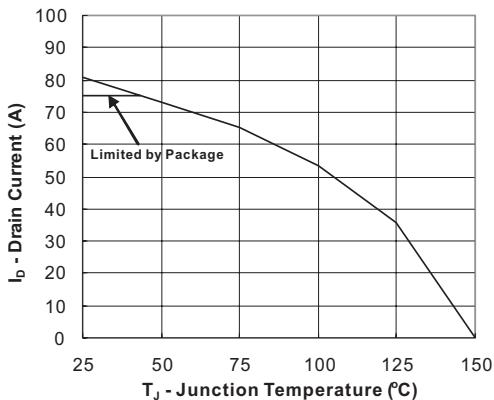


Fig.11 - Maximum Drain Current vs Junction Temperature

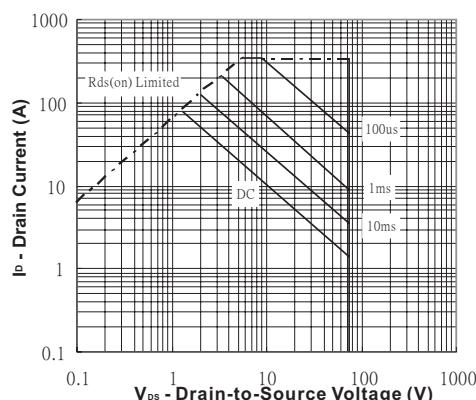


Fig.12 - Safe Operation Area

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